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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

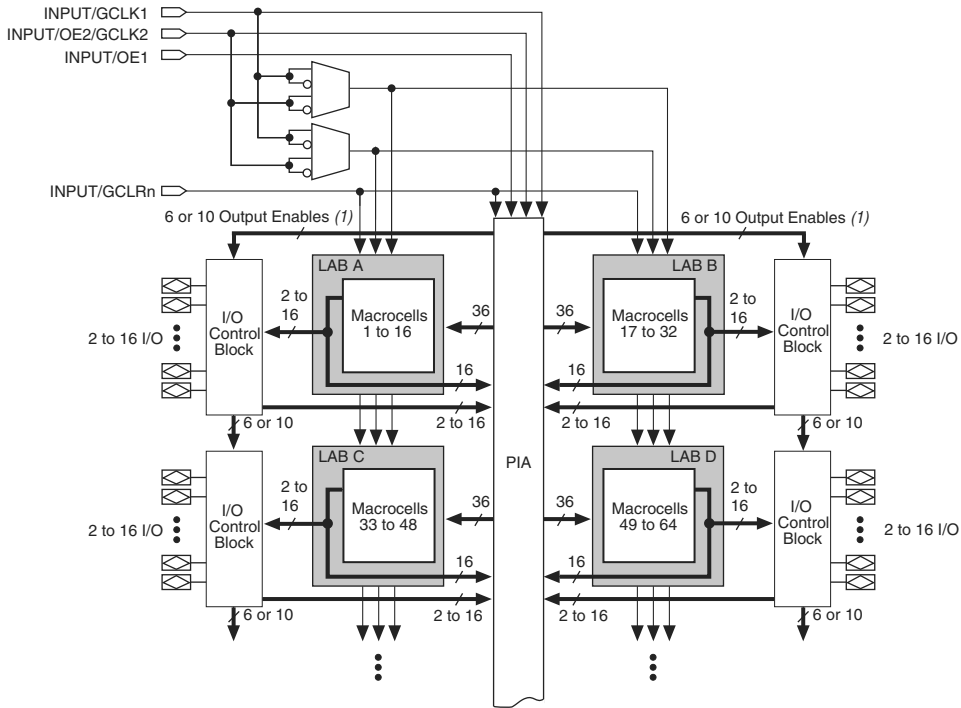
| | |
|---------------------------------|---|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 7.5 ns |
| Voltage Supply - Internal | 3V ~ 3.6V |
| Number of Logic Elements/Blocks | 4 |
| Number of Macrocells | 64 |
| Number of Gates | 1250 |
| Number of I/O | 34 |
| Operating Temperature | 0°C ~ 70°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 44-LCC (J-Lead) |
| Supplier Device Package | 44-PLCC (16.59x16.59) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/epm3064alc44-7n |

...and More Features

- PCI compatible
- Bus-friendly architecture including programmable slew-rate control
- Open-drain output option
- Programmable macrocell flipflops with individual clear, preset, clock, and clock enable controls
- Programmable power-saving mode for a power reduction of over 50% in each macrocell
- Configurable expander product-term distribution, allowing up to 32 product terms per macrocell
- Programmable security bit for protection of proprietary designs
- Enhanced architectural features, including:
 - 6 or 10 pin- or logic-driven output enable signals
 - Two global clock signals with optional inversion
 - Enhanced interconnect resources for improved routability
 - Programmable output slew-rate control
- Software design support and automatic place-and-route provided by Altera's development systems for Windows-based PCs and Sun SPARCstations, and HP 9000 Series 700/800 workstations
- Additional design entry and simulation support provided by EDIF 2.0.0 and 3.0.0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from third-party manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and VeriBest
- Programming support with the Altera master programming unit (MPU), MasterBlaster™ communications cable, ByteBlasterMV™ parallel port download cable, BitBlaster™ serial download cable as well as programming hardware from third-party manufacturers and any in-circuit tester that supports Jam™ Standard Test and Programming Language (STAPL) Files (.jam), Jam STAPL Byte-Code Files (.jbc), or Serial Vector Format Files (.svf)

General Description

MAX 3000A devices are low-cost, high-performance devices based on the Altera MAX architecture. Fabricated with advanced CMOS technology, the EEPROM-based MAX 3000A devices operate with a 3.3-V supply voltage and provide 600 to 10,000 usable gates, ISP, pin-to-pin delays as fast as 4.5 ns, and counter speeds of up to 227.3 MHz. MAX 3000A devices in the -4, -5, -6, -7, and -10 speed grades are compatible with the timing requirements of the PCI Special Interest Group (PCI SIG) *PCI Local Bus Specification, Revision 2.2*. See Table 2.

Figure 1. MAX 3000A Device Block Diagram**Note:**

- (1) EPM3032A, EPM3064A, EPM3128A, and EPM3256A devices have six output enables. EPM3512A devices have 10 output enables.

Logic Array Blocks

The MAX 3000A device architecture is based on the linking of high-performance LABs. LABs consist of 16-macrocell arrays, as shown in Figure 1. Multiple LABs are linked together via the PIA, a global bus that is fed by all dedicated input pins, I/O pins, and macrocells.

Each LAB is fed by the following signals:

- 36 signals from the PIA that are used for general logic inputs
- Global controls that are used for secondary register functions

Expander Product Terms

Although most logic functions can be implemented with the five product terms available in each macrocell, highly complex logic functions require additional product terms. Another macrocell can be used to supply the required logic resources. However, the MAX 3000A architecture also offers both shareable and parallel expander product terms ("expanders") that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

Shareable Expanders

Each LAB has 16 shareable expanders that can be viewed as a pool of uncommitted single product terms (one from each macrocell) with inverted outputs that feed back into the logic array. Each shareable expander can be used and shared by any or all macrocells in the LAB to build complex logic functions. Shareable expanders incur a small delay (t_{SEXP}). Figure 3 shows how shareable expanders can feed multiple macrocells.

Figure 3. MAX 3000A Shareable Expanders

Shareable expanders can be shared by any or all macrocells in an LAB.

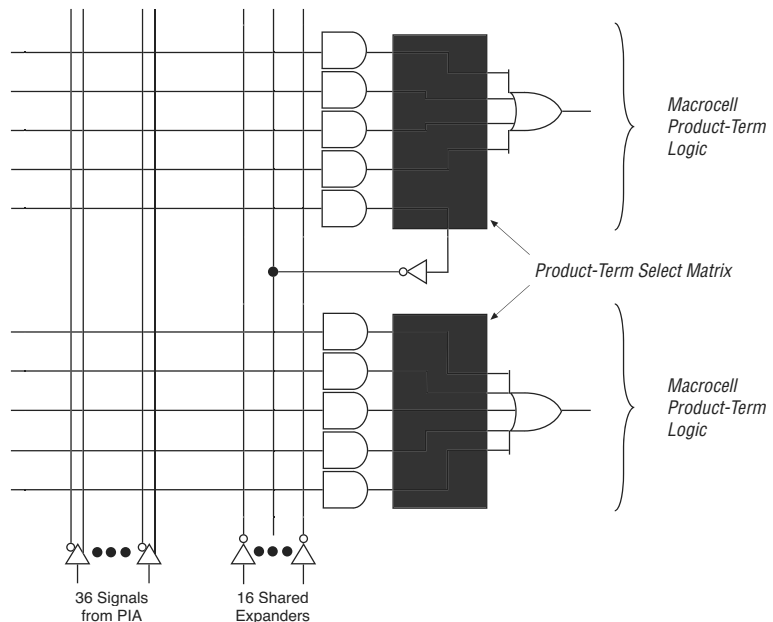
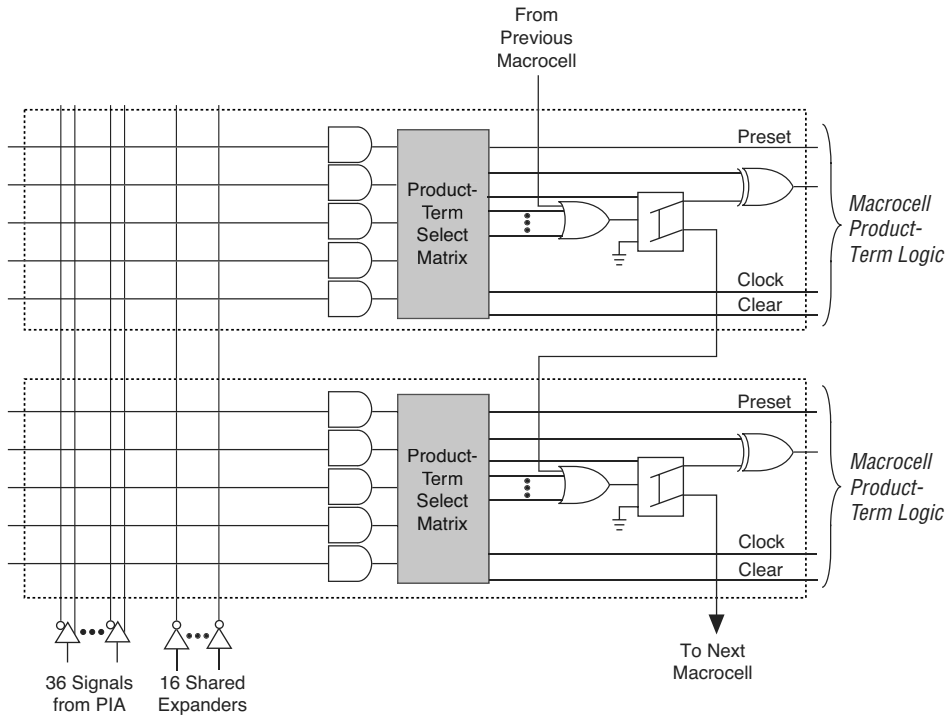


Figure 4. MAX 3000A Parallel Expanders

Unused product terms in a macrocell can be allocated to a neighboring macrocell.



Programmable Interconnect Array

Logic is routed between LABs on the PIA. This global bus is a programmable path that connects any signal source to any destination on the device. All MAX 3000A dedicated inputs, I/O pins, and macrocell outputs feed the PIA, which makes the signals available throughout the entire device. Only the signals required by each LAB are actually routed from the PIA into the LAB. Figure 5 shows how the PIA signals are routed into the LAB. An EEPROM cell controls one input to a two-input AND gate, which selects a PIA signal to drive into the LAB.

Programming Sequence

During in-system programming, instructions, addresses, and data are shifted into the MAX 3000A device through the TDI input pin. Data is shifted out through the TDO output pin and compared against the expected data.

Programming a pattern into the device requires the following six ISP stages. A stand-alone verification of a programmed pattern involves only stages 1, 2, 5, and 6.

1. *Enter ISP.* The enter ISP stage ensures that the I/O pins transition smoothly from user mode to ISP mode. The enter ISP stage requires 1 ms.
2. *Check ID.* Before any program or verify process, the silicon ID is checked. The time required to read this silicon ID is relatively small compared to the overall programming time.
3. *Bulk Erase.* Erasing the device in-system involves shifting in the instructions to erase the device and applying one erase pulse of 100 ms.
4. *Program.* Programming the device in-system involves shifting in the address and data and then applying the programming pulse to program the EEPROM cells. This process is repeated for each EEPROM address.
5. *Verify.* Verifying an Altera device in-system involves shifting in addresses, applying the read pulse to verify the EEPROM cells, and shifting out the data for comparison. This process is repeated for each EEPROM address.
6. *Exit ISP.* An exit ISP stage ensures that the I/O pins transition smoothly from ISP mode to user mode. The exit ISP stage requires 1 ms.

Programming Times

The time required to implement each of the six programming stages can be broken into the following two elements:

- A pulse time to erase, program, or read the EEPROM cells.
- A shifting time based on the test clock (TCK) frequency and the number of TCK cycles to shift instructions, address, and data into the device.

By combining the pulse and shift times for each of the programming stages, the program or verify time can be derived as a function of the TCK frequency, the number of devices, and specific target device(s). Because different ISP-capable devices have a different number of EEPROM cells, both the total fixed and total variable times are unique for a single device.

Programming a Single MAX 3000A Device

The time required to program a single MAX 3000A device in-system can be calculated from the following formula:

$$t_{PROG} = t_{PPULSE} + \frac{Cycle_{PTCK}}{f_{TCK}}$$

where: t_{PROG} = Programming time
 t_{PPULSE} = Sum of the fixed times to erase, program, and verify the EEPROM cells
 $Cycle_{PTCK}$ = Number of TCK cycles to program a device
 f_{TCK} = TCK frequency

The ISP times for a stand-alone verification of a single MAX 3000A device can be calculated from the following formula:

$$t_{VER} = t_{VPULSE} + \frac{Cycle_{VTCK}}{f_{TCK}}$$

where: t_{VER} = Verify time
 t_{VPULSE} = Sum of the fixed times to verify the EEPROM cells
 $Cycle_{VTCK}$ = Number of TCK cycles to verify a device

The instruction register length of MAX 3000A devices is 10 bits. The IDCODE and USERCODE register length is 32 bits. Tables 8 and 9 show the boundary-scan register length and device IDCODE information for MAX 3000A devices.

Table 8. MAX 3000A Boundary-Scan Register Length

| Device | Boundary-Scan Register Length |
|----------|-------------------------------|
| EPM3032A | 96 |
| EPM3064A | 192 |
| EPM3128A | 288 |
| EPM3256A | 480 |
| EPM3512A | 624 |

Table 9. 32-Bit MAX 3000A Device IDCODE Value Note (1)

| Device | IDCODE (32 bits) | | | |
|----------|------------------|-----------------------|-----------------------------------|---------------|
| | Version (4 Bits) | Part Number (16 Bits) | Manufacturer's Identity (11 Bits) | 1 (1 Bit) (2) |
| EPM3032A | 0001 | 0111 0000 0011 0010 | 00001101110 | 1 |
| EPM3064A | 0001 | 0111 0000 0110 0100 | 00001101110 | 1 |
| EPM3128A | 0001 | 0111 0001 0010 1000 | 00001101110 | 1 |
| EPM3256A | 0001 | 0111 0010 0101 0110 | 00001101110 | 1 |
| EPM3512A | 0001 | 0111 0101 0001 0010 | 00001101110 | 1 |

Notes:

- (1) The most significant bit (MSB) is on the left.
- (2) The least significant bit (LSB) for all JTAG IDCODEs is 1.



See *Application Note 39 (IEEE 1149.1 (JTAG) Boundary-Scan Testing in Altera Devices)* for more information on JTAG BST.

Table 15. MAX 3000A Device Capacitance Note (9)

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-----------------------|---|-----|-----|------|
| C_{IN} | Input pin capacitance | $V_{IN} = 0\text{ V}$, $f = 1.0\text{ MHz}$ | | 8 | pF |
| $C_{I/O}$ | I/O pin capacitance | $V_{OUT} = 0\text{ V}$, $f = 1.0\text{ MHz}$ | | 8 | pF |

Notes to tables:

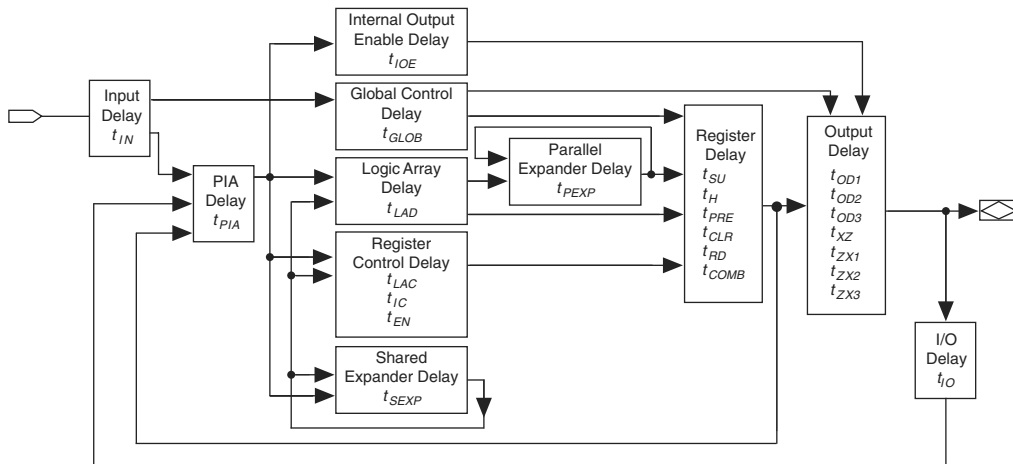
- (1) See the *Operating Requirements for Altera Devices Data Sheet*.
- (2) Minimum DC input voltage is -0.5 V . During transitions, the inputs may undershoot to -2.0 V or overshoot to 5.75 V for input currents less than 100 mA and periods shorter than 20 ns .
- (3) All pins, including dedicated inputs, I/O pins, and JTAG pins, may be driven before V_{CCINT} and V_{CCIO} are powered.
- (4) These values are specified under the recommended operating conditions, as shown in Table 13 on page 23.
- (5) The parameter is measured with 50% of the outputs each sourcing the specified current. The I_{OH} parameter refers to high-level TTL or CMOS output current.
- (6) The parameter is measured with 50% of the outputs each sinking the specified current. The I_{OL} parameter refers to low-level TTL, PCI, or CMOS output current.
- (7) This value is specified during normal device operation. During power-up, the maximum leakage current is $\pm 300\text{ }\mu\text{A}$.
- (8) This pull-up exists while devices are programmed in-system and in unprogrammed devices during power-up.
- (9) Capacitance is measured at 25° C and is sample-tested only. The OE1 pin (high-voltage pin during programming) has a maximum capacitance of 20 pF .
- (10) The POR time for all MAX 3000A devices does not exceed $100\text{ }\mu\text{s}$. The sufficient V_{CCINT} voltage level for POR is 3.0 V . The device is fully initialized within the POR time after V_{CCINT} reaches the sufficient POR voltage level.
- (11) These devices support in-system programming for -40° to 100° C . For in-system programming support between -40° and 0° C , contact Altera Applications.

Figure 9 shows the typical output drive characteristics of MAX 3000A devices.

Timing Model

MAX 3000A device timing can be analyzed with the Altera software, with a variety of popular industry-standard EDA simulators and timing analyzers, or with the timing model shown in Figure 10. MAX 3000A devices have predictable internal delays that enable the designer to determine the worst-case timing of any design. The software provides timing simulation, point-to-point delay prediction, and detailed timing analysis for device-wide performance evaluation.

Figure 10. MAX 3000A Timing Model



The timing characteristics of any signal path can be derived from the timing model and parameters of a particular device. External timing parameters, which represent pin-to-pin timing delays, can be calculated as the sum of internal parameters. Figure 11 shows the timing relationship between internal and external delay parameters.

Table 17. EPM3032A Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-----------|-----------------|------------|-------------|-----|-----|-----|-----|-----|------|
| | | | −4 | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{PIA} | PIA delay | (2) | | 0.9 | | 1.5 | | 2.1 | ns |
| t_{LPA} | Low-power adder | (5) | | 2.5 | | 4.0 | | 5.0 | ns |

Table 18. EPM3064A External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-------------------|--|----------------|-------------|-----|-------|-----|-------|------|------|
| | | | −4 | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF (2) | | 4.5 | | 7.5 | | 10.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF (2) | | 4.5 | | 7.5 | | 10.0 | ns |
| t _{SU} | Global clock setup time | (2) | 2.8 | | 4.7 | | 6.2 | | ns |
| t _H | Global clock hold time | (2) | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | 1.0 | 3.1 | 1.0 | 5.1 | 1.0 | 7.0 | ns |
| t _{CH} | Global clock high time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | (2) | 1.6 | | 2.6 | | 3.6 | | ns |
| t _{AH} | Array clock hold time | (2) | 0.3 | | 0.4 | | 0.6 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF (2) | 1.0 | 4.3 | 1.0 | 7.2 | 1.0 | 9.6 | ns |
| t _{ACH} | Array clock high time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CNT} | Minimum global clock period | (2) | | 4.5 | | 7.4 | | 10.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (2), (4) | 222.2 | | 135.1 | | 100.0 | | MHz |
| t _{ACNT} | Minimum array clock period | (2) | | 4.5 | | 7.4 | | 10.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (2), (4) | 222.2 | | 135.1 | | 100.0 | | MHz |

Table 19. EPM3064A Internal Timing Parameters (Part 1 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|---|---------------------|-------------|-----|-----|-----|-----|------|------|
| | | | −4 | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.6 | | 1.1 | | 1.4 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.6 | | 1.1 | | 1.4 | ns |
| t_{SEXP} | Shared expander delay | | | 1.8 | | 3.0 | | 3.9 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.4 | | 0.7 | | 0.9 | ns |
| t_{LAD} | Logic array delay | | | 1.5 | | 2.5 | | 3.2 | ns |
| t_{LAC} | Logic control array delay | | | 0.6 | | 1.0 | | 1.2 | ns |
| t_{IOE} | Internal output enable delay | | | 0.0 | | 0.0 | | 0.0 | ns |
| t_{OD1} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 0.8 | | 1.3 | | 1.8 | ns |
| t_{OD2} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ | | 1.3 | | 1.8 | | 2.3 | ns |
| t_{OD3} | Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ | | 5.8 | | 6.3 | | 6.8 | ns |
| t_{ZX1} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{ZX2} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ | | 4.5 | | 4.5 | | 5.5 | ns |
| t_{ZX3} | Output buffer enable delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ | | 9.0 | | 9.0 | | 10.0 | ns |
| t_{XZ} | Output buffer disable delay | $C1 = 5\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 1.3 | | 2.0 | | 2.9 | | ns |
| t_H | Register hold time | | 0.6 | | 1.0 | | 1.3 | | ns |
| t_{RD} | Register delay | | | 0.7 | | 1.2 | | 1.6 | ns |
| t_{COMB} | Combinatorial delay | | | 0.6 | | 0.9 | | 1.3 | ns |
| t_{IC} | Array clock delay | | | 1.2 | | 1.9 | | 2.5 | ns |
| t_{EN} | Register enable time | | | 0.6 | | 1.0 | | 1.2 | ns |
| t_{GLOB} | Global control delay | | | 1.0 | | 1.5 | | 2.2 | ns |
| t_{PRE} | Register preset time | | | 1.3 | | 2.1 | | 2.9 | ns |

Table 19. EPM3064A Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-----------|---------------------|------------|-------------|-----|-----|-----|-----|-----|------|
| | | | −4 | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{CLR} | Register clear time | | | 1.3 | | 2.1 | | 2.9 | ns |
| t_{PIA} | PIA delay | (2) | | 1.0 | | 1.7 | | 2.3 | ns |
| t_{LPA} | Low-power adder | (5) | | 3.5 | | 4.0 | | 5.0 | ns |

Table 20. EPM3128A External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-------------------|--|-------------------|-------------|-----|-------|-----|------|------|------|
| | | | −5 | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non–registered output | C1 = 35 pF (2) | | 5.0 | | 7.5 | | 10 | ns |
| t _{PD2} | I/O input to non–registered output | C1 = 35 pF (2) | | 5.0 | | 7.5 | | 10 | ns |
| t _{SU} | Global clock setup time | (2) | 3.3 | | 4.9 | | 6.6 | | ns |
| t _H | Global clock hold time | (2) | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | 1.0 | 3.4 | 1.0 | 5.0 | 1.0 | 6.6 | ns |
| t _{CH} | Global clock high time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | (2) | 1.8 | | 2.8 | | 3.8 | | ns |
| t _{AH} | Array clock hold time | (2) | 0.2 | | 0.3 | | 0.4 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF (2) | 1.0 | 4.9 | 1.0 | 7.1 | 1.0 | 9.4 | ns |
| t _{ACH} | Array clock high time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CNT} | Minimum global clock period | (2) | | 5.2 | | 7.7 | | 10.2 | ns |
| f _{CNT} | Maximum internal global clock frequency | (2), (4) | 192.3 | | 129.9 | | 98.0 | | MHz |
| t _{ACNT} | Minimum array clock period | (2) | | 5.2 | | 7.7 | | 10.2 | ns |

Table 21. EPM3128A Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|----------------------|------------|-------------|-----|-----|-----|-----|-----|------|
| | | | −5 | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{SU} | Register setup time | | 1.4 | | 2.1 | | 2.9 | | ns |
| t_H | Register hold time | | 0.6 | | 1.0 | | 1.3 | | ns |
| t_{RD} | Register delay | | | 0.8 | | 1.2 | | 1.6 | ns |
| t_{COMB} | Combinatorial delay | | | 0.5 | | 0.9 | | 1.3 | ns |
| t_{IC} | Array clock delay | | | 1.2 | | 1.7 | | 2.2 | ns |
| t_{EN} | Register enable time | | | 0.7 | | 1.0 | | 1.3 | ns |
| t_{GLOB} | Global control delay | | | 1.1 | | 1.6 | | 2.0 | ns |
| t_{PRE} | Register preset time | | | 1.4 | | 2.0 | | 2.7 | ns |
| t_{CLR} | Register clear time | | | 1.4 | | 2.0 | | 2.7 | ns |
| t_{PIA} | PIA delay | (2) | | 1.4 | | 2.0 | | 2.6 | ns |
| t_{LPA} | Low-power adder | (5) | | 4.0 | | 4.0 | | 5.0 | ns |

Table 22. EPM3256A External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | Unit |
|-------------------|--|----------------|-------------|-----|-----|-----|------|
| | | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF (2) | | 7.5 | | 10 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF (2) | | 7.5 | | 10 | ns |
| t _{SU} | Global clock setup time | (2) | 5.2 | | 6.9 | | ns |
| t _H | Global clock hold time | (2) | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | 1.0 | 4.8 | 1.0 | 6.4 | ns |
| t _{CH} | Global clock high time | | 3.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 3.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | (2) | 2.7 | | 3.6 | | ns |
| t _{AH} | Array clock hold time | (2) | 0.3 | | 0.5 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF (2) | 1.0 | 7.3 | 1.0 | 9.7 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 3.0 | | 4.0 | | ns |

Table 22. EPM3256A External Timing Parameters Note (1)

| Symbol | Parameter | Conditions | Speed Grade | | | | Unit |
|-------------------|---|------------|-------------|-----|------|------|------|
| | | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | |
| t _{CNT} | Minimum global clock period | (2) | | 7.9 | | 10.5 | ns |
| f _{CNT} | Maximum internal global clock frequency | (2), (4) | 126.6 | | 95.2 | | MHz |
| t _{ACNT} | Minimum array clock period | (2) | | 7.9 | | 10.5 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (2), (4) | 126.6 | | 95.2 | | MHz |

Table 23. EPM3256A Internal Timing Parameters (Part 1 of 2) Note (1)

| Symbol | Parameter | Conditions | Speed Grade | | | | Unit |
|------------|--|---------------------|-------------|-----|-----|-----|------|
| | | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.9 | | 1.2 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.9 | | 1.2 | ns |
| t_{SEXP} | Shared expander delay | | | 2.8 | | 3.7 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.5 | | 0.6 | ns |
| t_{LAD} | Logic array delay | | | 2.2 | | 2.8 | ns |
| t_{LAC} | Logic control array delay | | | 1.0 | | 1.3 | ns |
| t_{IOE} | Internal output enable delay | | | 0.0 | | 0.0 | ns |
| t_{OD1} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 1.2 | | 1.6 | ns |
| t_{OD2} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ | | 1.7 | | 2.1 | ns |
| t_{OD3} | Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ | | 6.2 | | 6.6 | ns |
| t_{ZX1} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 4.0 | | 5.0 | ns |
| t_{ZX2} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ | | 4.5 | | 5.5 | ns |

Table 23. EPM3256A Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | Unit |
|------------|--|---------------------|-------------|-----|-----|------|------|
| | | | −7 | | −10 | | |
| | | | Min | Max | Min | Max | |
| t_{ZX3} | Output buffer enable delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ | | 9.0 | | 10.0 | ns |
| t_{XZ} | Output buffer disable delay | $C1 = 5\text{ pF}$ | | 4.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 2.1 | | 2.9 | | ns |
| t_H | Register hold time | | 0.9 | | 1.2 | | ns |
| t_{RD} | Register delay | | | 1.2 | | 1.6 | ns |
| t_{COMB} | Combinatorial delay | | | 0.8 | | 1.2 | ns |
| t_{IC} | Array clock delay | | | 1.6 | | 2.1 | ns |
| t_{EN} | Register enable time | | | 1.0 | | 1.3 | ns |
| t_{GLOB} | Global control delay | | | 1.5 | | 2.0 | ns |
| t_{PRE} | Register preset time | | | 2.3 | | 3.0 | ns |
| t_{CLR} | Register clear time | | | 2.3 | | 3.0 | ns |
| t_{PIA} | PIA delay | (2) | | 2.4 | | 3.2 | ns |
| t_{LPA} | Low-power adder | (5) | | 4.0 | | 5.0 | ns |

Table 24. EPM3512A External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | Unit |
|------------------|---------------------------------------|----------------|-------------|-----|-----|------|------|
| | | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF (2) | | 7.5 | | 10.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF (2) | | 7.5 | | 10.0 | ns |
| t _{SU} | Global clock setup time | (2) | 5.6 | | 7.6 | | ns |
| t _H | Global clock hold time | (2) | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | 1.0 | 4.7 | 1.0 | 6.3 | ns |
| t _{CH} | Global clock high time | | 3.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 3.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | (2) | 2.5 | | 3.5 | | ns |

Table 24. EPM3512A External Timing Parameters Note (1)

| Symbol | Parameter | Conditions | Speed Grade | | | | Unit |
|-------------------|--|----------------|-------------|-----|------|------|------|
| | | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | |
| t _{AH} | Array clock hold time | (2) | 0.2 | | 0.3 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF (2) | 1.0 | 7.8 | 1.0 | 10.4 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 3.0 | | 4.0 | | ns |
| t _{CNT} | Minimum global clock period | (2) | | 8.6 | | 11.5 | ns |
| f _{CNT} | Maximum internal global clock frequency | (2), (4) | 116.3 | | 87.0 | | MHz |
| t _{ACNT} | Minimum array clock period | (2) | | 8.6 | | 11.5 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (2), (4) | 116.3 | | 87.0 | | MHz |

Table 25. EPM3512A Internal Timing Parameters (Part 1 of 2) Note (1)

| Symbol | Parameter | Conditions | Speed Grade | | | | Unit |
|------------|---|------------|-------------|-----|-----|-----|------|
| | | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.7 | | 0.9 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.7 | | 0.9 | ns |
| t_{FIN} | Fast input delay | | | 3.1 | | 3.6 | ns |
| t_{SEXP} | Shared expander delay | | | 2.7 | | 3.5 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.4 | | 0.5 | ns |
| t_{LAD} | Logic array delay | | | 2.2 | | 2.8 | ns |
| t_{LAC} | Logic control array delay | | | 1.0 | | 1.3 | ns |
| t_{IOE} | Internal output enable delay | | | 0.0 | | 0.0 | ns |
| t_{OD1} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | C1 = 35 pF | | 1.0 | | 1.5 | ns |
| t_{OD2} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | C1 = 35 pF | | 1.5 | | 2.0 | ns |

Device Pin-Outs

See the Altera web site (<http://www.altera.com>) or the *Altera Digital Library* for pin-out information.

Figures 14 through 18 show the package pin-out diagrams for MAX 3000A devices.

Figure 14. 44-Pin PLCC/TQFP Package Pin-Out Diagram

Package outlines not drawn to scale.

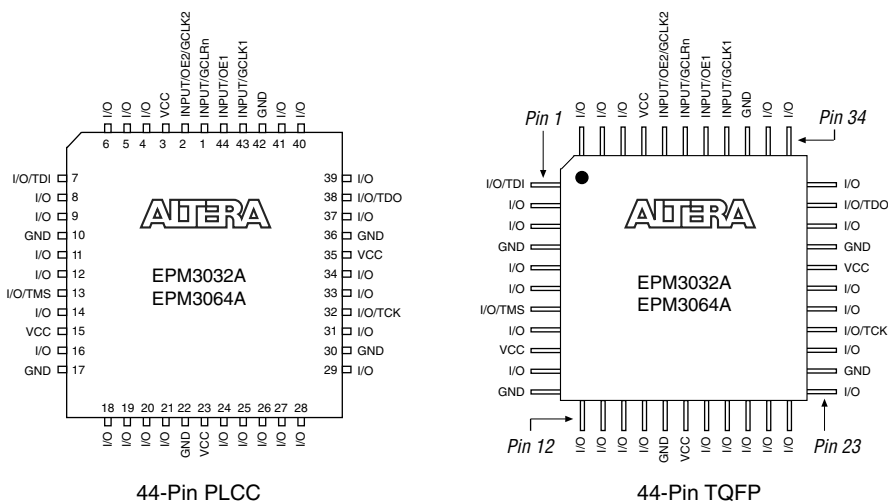
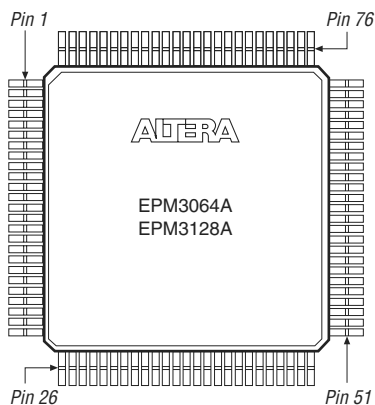


Figure 15. 100-Pin TQFP Package Pin-Out Diagram

Package outline not drawn to scale.

**Figure 16. 144-Pin TQFP Package Pin-Out Diagram**

Package outline not drawn to scale.

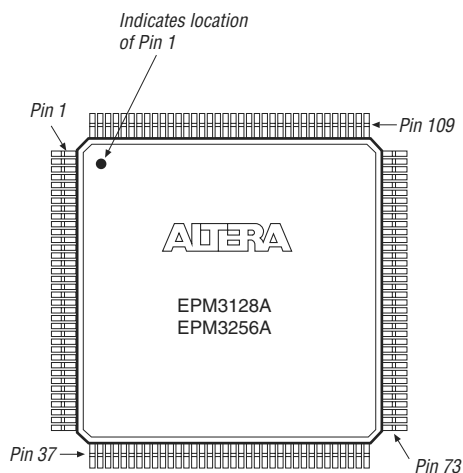
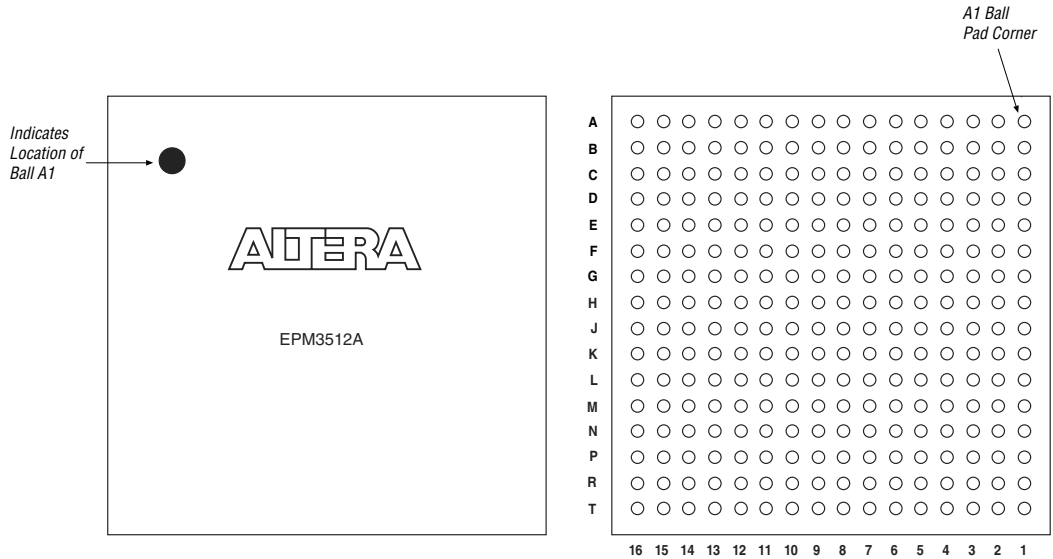


Figure 18. 256-Pin FineLine BGA Package Pin-Out Diagram

Package outline not drawn to scale.



Revision History

The information contained in the *MAX 3000A Programmable Logic Device Data Sheet* version 3.5 supersedes information published in previous versions. The following changes were made in the *MAX 3000A Programmable Logic Device Data Sheet* version 3.5:

Version 3.5

The following changes were made in the *MAX 3000A Programmable Logic Device Data Sheet* version 3.5:

- New paragraph added before “Expander Product Terms”.

Version 3.4

The following changes were made in the *MAX 3000A Programmable Logic Device Data Sheet* version 3.4:

- Updated Table 1.

Version 3.3

The following changes were made in the *MAX 3000A Programmable Logic Device Data Sheet* version 3.3:

- Updated Tables 3, 13, and 26.
- Added Tables 4 through 6.
- Updated Figures 12 and 13.
- Added “Programming Sequence” on page 14 and “Programming Times” on page 14

Version 3.2

The following change were made in the *MAX 3000A Programmable Logic Device Data Sheet* version 3.2:

- Updated the EPM3512 I_{CC} versus frequency graph in Figure 13.

Version 3.1

The following changes were made in the *MAX 3000A Programmable Logic Device Data Sheet* version 3.1:

- Updated timing information in Table 1 for the EPM3256A device.
- Updated *Note (10)* of Table 15.

Version 3.0

The following changes were made in the *MAX 3000A Programmable Logic Device Data Sheet* version 3.0:

- Added EPM3512A device.
- Updated Tables 2 and 3.

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